



SPECIFICATION

(Reference sheet)

· Supplier : Samsung electro-mechanics · Samsung P/N : CL10B104KC8NNNC

Product : Multi-layer Ceramic Capacitor

Description : CAP, 100nF, 100V, ±10%, X7R, 0603

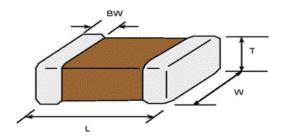
A. Samsung Part Number

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1	Series	Samsung Multi-layer Ceramic Capacitor				
2	Size	0603 (inch code)	L: 1.60 ± 0.10 mm	W: 0.80 ± 0.10 mm		
3	Dielectric	X7R	8 Inner electrode	Ni		
4	Capacitance	100 nF	Termination	Cu		
⑤	Capacitance	±10 %	Plating	Sn 100% (Pb Free)		
	tolerance		9 Product	Normal		
6	Rated Voltage	100 V	⑩ Special	Reserved for future use		
7	Thickness	0.80 ± 0.10 mm	① Packaging	Cardboard Type, 7" reel		

B. Structure & Dimension



Sameung D/N	Dimension(mm)				
Samsung P/N	L	W	Т	BW	
CL10B104KC8NNNC	1.60 ± 0.10	0.80 ± 0.10	0.80 ± 0.10	0.30 ± 0.20	

C. Samsung Reliablility Test and Judgement Condition

	Judgement	Test condition		
Capacitance	Within specified tolerance	1kHz ±10% / 1.0±0.2Vrms		
Tan δ (DF)	0.025 max.	*A capacitor prior to measuring the capacitance is heat treated at 150 ℃+0/-10 ℃ for 1hour and maintained in ambient air for 24±2 hours.		
Insulation	10,000Mohm or 500Mohm×μF	Rated Voltage 60±5 sec.		
Resistance	Whichever is smaller			
Appearance	No abnormal exterior appearance	Microscope (×10)		
Vithstanding No dielectric breakdown or		200% of the rated voltage		
Voltage	mechanical breakdown			
Temperature	X7R			
Characteristics	(From -55 $^{\circ}\!$	should be within ±15%)		
Adhesive Strength	No peeling shall be occur on the	500g·f, for 10±1 sec.		
of Termination	terminal electrode			
Bending Strength	Capacitance change : within ±12.5%	Bending to the limit (1 ^{mm}) with 1.0mm/sec.		
Solderability	More than 95% of terminal surface is to be soldered newly	SnAg3.0Cu0.5 solder 245±5°C, 3±0.3sec. (preheating : 80~120°C for 10~30sec.)		
Resistance to	Capacitance change : within ±7.5%	Solder pot : 270±5°C, 10±1sec.		
Soldering Heat	Tan δ, IR: initial spec.	1		
Vibration Test	Capacitance change : within \pm 5% Tan δ , IR : initial spec.	Amplitude: 1.5mm From 10Hz to 55Hz (return: 1min.) 2hours × 3 direction (x, y, z)		
Moisture	Capacitance change: within ±12.5%	With rated voltage		
Resistance	Tan δ : 0.05 max IR : 500Mohm or 25Mohm × μF Whichever is smaller	40±2°C, 90~95%RH, 500+12/-0hrs		
High Temperature	Capacitance change : within ±12.5%	With 200% of the rated voltage		
Resistance	Tan δ : 0.05 max	Max. operating temperature		
	IR : 1,000Mohm or 50Mohm × μ F Whichever is smaller	1,000+48/-0hrs		
Temperature	Capacitance change: within ±7.5%	1 cycle condition		
Cycling	Tan δ, IR : initial spec.	Min. operating temperature → 25°C → Max. operating temperature → 25°C		
		5 cycle test		

X The reliability test condition can be replaced by the corresponding accelerated test condition.

D. Recommended Soldering method:

Reflow (Reflow Peak Temperature : 250 ℃, 6sec. max.)



Product specifications included in the specifications are effective as of March 1, 2013.

Please be advised that they are standard product specifications for reference only.

We may change, modify or discontinue the product specifications without notice at any time.

So, you need to approve the product specifications before placing an order.

Should you have any question regarding the product specifications,

please contact our sales personnel or application engineers.